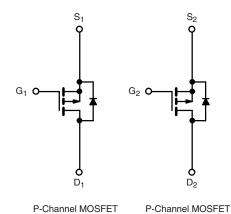


# SI6981DQ-T1-GE3-VB Datasheet Dual P-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY				
V <sub>DS</sub> (V)	$R_{DS(on)}(\Omega)$	I <sub>D</sub> (A) <sup>d</sup>	Q <sub>g</sub> (Typ.)	
	0.013 at V <sub>GS</sub> = - 4.5 V	-7.5		
- 20	0.018 at V <sub>GS</sub> = - 2.5 V	-6.5	20 nC	
	0.032 at V <sub>GS</sub> = - 1.8 V	-5.0		



#### **FEATURES**

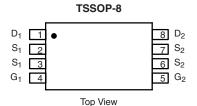
- Halogen-free According to IEC 61249-2-21 Definition
- Trench Power MOSFET
- 100 % R<sub>g</sub> Tested
- 100 % UIS Tested
- Compliant to RoHS Directive 2002/95/EC



ROHS COMPLIANT HALOGEN FREE

#### **APPLICATIONS**

- · Adaptor Switch
- · High Current Load Switch
- Notebook



Parameter	Symbol	Limit	Unit	
Drain-Source Voltage	V <sub>DS</sub>	- 20	V	
Gate-Source Voltage		V <sub>GS</sub>	± 12	
	T <sub>C</sub> = 25 °C		- 7.5	
Continuous Prain Current /T = 150 °C	T <sub>C</sub> = 70 °C	1 , $\sqsubset$	- 6.0	
Continuous Drain Current (T <sub>J</sub> = 150 °C)	T <sub>A</sub> = 25 °C	I <sub>D</sub>	- 5.4 <sup>a, b</sup>	
	T <sub>A</sub> = 70 °C		- 4.5 <sup>a, b</sup>	Α .
Pulsed Drain Current		I <sub>DM</sub>	- 30	A
Continuous Course Dunin Diada Courset	T <sub>C</sub> = 25 °C		- 4.1	
Continuous Source-Drain Diode Current	T <sub>A</sub> = 25 °C	I <sub>S</sub>	- 2.1 <sup>a, b</sup>	
Avalanche Current	1 0411	I <sub>AS</sub>	- 15	
Single-Pulse Avalanche Energy L = 0.1 mH		E <sub>AS</sub>	11.25	mJ
	T <sub>C</sub> = 25 °C		5	
Mariana Paran Dissipation	T <sub>C</sub> = 70 °C	1 5 -	3.2	w
Maximum Power Dissipation	T <sub>A</sub> = 25 °C	P <sub>D</sub>	2.5 <sup>a, b</sup>	VV
	T <sub>A</sub> = 70 °C	1	1.6 <sup>a, b</sup>	
Operating Junction and Storage Temperature Rang	T <sub>J</sub> , T <sub>sta</sub>	- 55 to 150	°C	

THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient <sup>a, c</sup>	t ≤ 10 s	R <sub>thJA</sub>	38	50	°C/W	
Maximum Junction-to-Foot	Steady State	$R_{thJF}$	20	25	O/ VV	

#### Notes:

- a. Surface mounted on 1" x 1" FR4 board.
- b. t = 10 s.
- c. Maximum under steady state conditions is 85  $^{\circ}\text{C/W}.$
- d. Based on  $T_C = 25$  °C.

服务热线:400-655-8788

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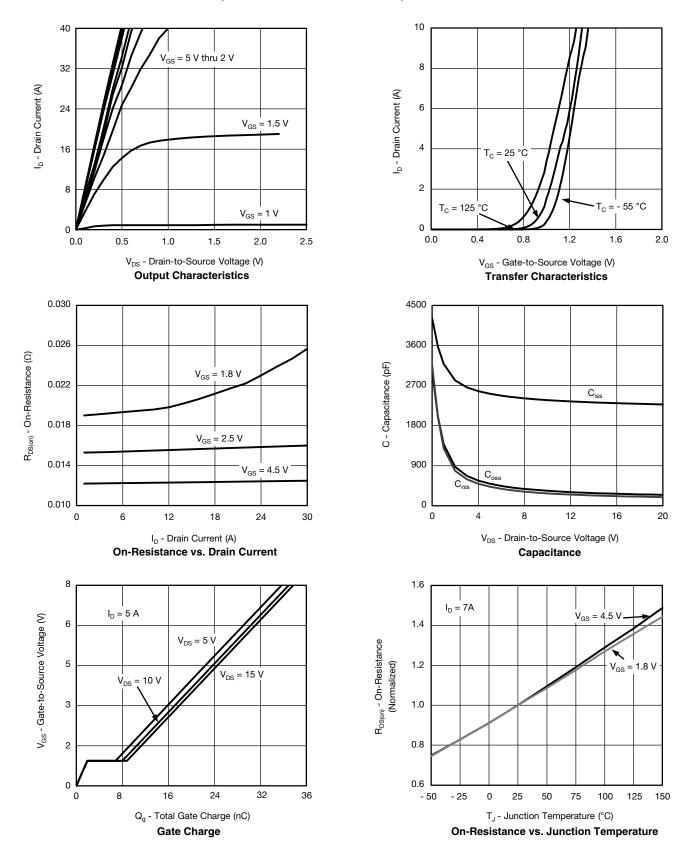
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = -250 \mu\text{A}$	- 20			V	
V <sub>DS</sub> Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I <sub>D</sub> = - 250 μA		- 14.5		mV/°C	
V <sub>GS(th)</sub> Temperature Coefficient	$\Delta V_{GS(th)}/T_J$			2.8			
Gate-Source Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.4		- 1.0	V	
Gate-Source Leakage	I <sub>GSS</sub>	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 8 \text{ V}$			± 100	nA	
Zava Cata Valtaga Dvain Curvent	I <sub>DSS</sub>	V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V			- 1	μА	
Zero Gate Voltage Drain Current		V <sub>DS</sub> = - 20 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 70 °C			- 10		
On-State Drain Current <sup>a</sup>	I <sub>D(on)</sub>	$V_{DS} \ge -10 \text{ V}, V_{GS} = -5 \text{ V}$	- 20			Α	
	, ,	V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 7 A		0.013		1	
Drain-Source On-State Resistance <sup>a</sup>	R <sub>DS(on)</sub>	V <sub>GS</sub> = - 2.5 V, I <sub>D</sub> = - 6 A		0.018		Ω	
	- (- )	V <sub>GS</sub> = - 1.8 V, I <sub>D</sub> = - 3 A		0.032			
Forward Transconductance <sup>a</sup>	9 <sub>fs</sub>	V <sub>DS</sub> = - 10 V, I <sub>D</sub> = - 9 A		40		S	
Dynamic <sup>b</sup>		, = - ,					
Input Capacitance	C <sub>iss</sub>			2380		pF	
Output Capacitance	C <sub>oss</sub>	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = 0 V, f = 1 MHz		340			
Reverse Transfer Capacitance	C <sub>rss</sub>	1		280			
T. 10 . 0	$Q_g = V_{DS} = -10 \text{ V}, V_{GS} = -$	V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 8 V, I <sub>D</sub> = - 5 A		45	70	nC	
Total Gate Charge		20 00 2		20	35		
Gate-Source Charge		V <sub>DS</sub> = - 10 V, V <sub>GS</sub> = - 4.5 V, I <sub>D</sub> = - 5 A		3.1			
Gate-Drain Charge	Q <sub>ad</sub>			8.4			
Gate Resistance	R <sub>q</sub>	f = 1 MHz	1.0	4.8	9.6	Ω	
Turn-On Delay Time	t <sub>d(on)</sub>			7	14		
Rise Time $t_r$		$V_{DD} = -10 \text{ V}, R_{L} = 2 \Omega$		9	18	-	
Turn-Off DelayTime	t <sub>d(off)</sub>	$I_D \cong -5 \text{ A}, V_{GEN} = -8 \text{ V}, R_g = 1 \Omega$		108	200	1	
Fall Time	t <sub>f</sub>			41	80		
Turn-On Delay Time t <sub>d(on</sub>				14	28	ns	
Rise Time	t <sub>r</sub>	$V_{DD}$ = - 10 V, $R_L$ = 2 $\Omega$ $I_D \cong$ - 5 A, $V_{GEN}$ = - 4.5 V, $R_g$ = 1 $\Omega$		16	32		
Turn-Off DelayTime	t <sub>d(off)</sub>			101	200		
Fall Time	t <sub>f</sub>			40	80		
<b>Drain-Source Body Diode Characteris</b>				<u> </u>			
Continous Source-Drain Diode Current					- 4.1		
Pulse Diode Forward Current	I <sub>SM</sub>	Ŭ			- 40	A	
Body Diode Voltage	V <sub>SD</sub>	I <sub>S</sub> = - 3 A, V <sub>GS</sub> = 0 V		- 0.66	- 1.2	V	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	5 · 40		81	150	ns	
Body Diode Reverse Recovery Charge	dy Diode Reverse Recovery Charge			150	300	nC	
Reverse Recovery Fall Time	t <sub>a</sub>	$I_F = -2.3 \text{ A, dI/dt} = 100 \text{ A/}\mu\text{s, T}_J = 25 ^{\circ}\text{C}$		43		ns	
Reverse Recovery Rise Time	t <sub>b</sub>	<del> </del>		38			

#### Notes:

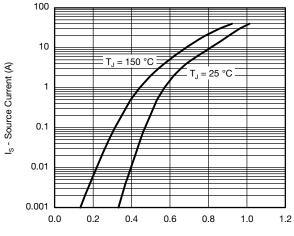
- a. Pulse test; pulse width  $\leq$  300  $\mu s,$  duty cycle  $\leq$  2 %.
- b. Guaranteed by design, not subject to production testing.

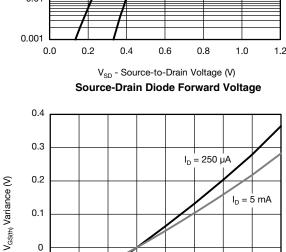
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.











0

- 0.1

- 0.2 - 50

- 25

0

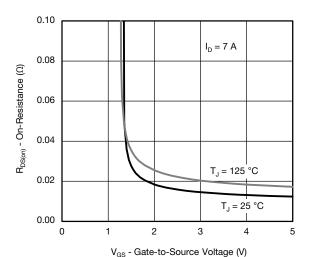
25

T<sub>J</sub> - Temperature (°C) **Threshold Voltage** 

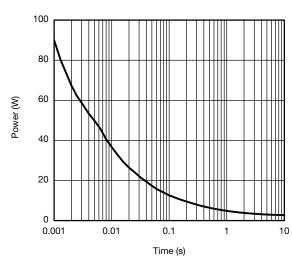
100

125

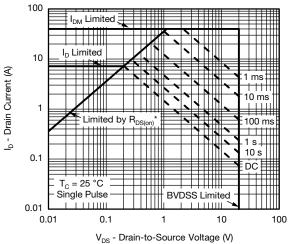
150



On-Resistance vs. Gate-to-Source Voltage

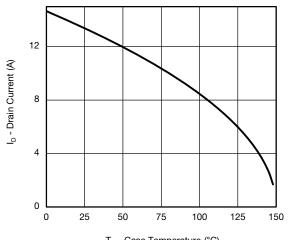


Single Pulse Power, Junction-to-Ambient



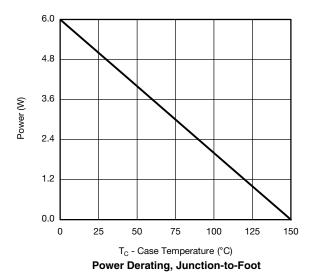
\*  $V_{\text{GS}} > \text{minimum } V_{\text{GS}}$  at which  $R_{\text{DS(on)}}$  is specified Safe Operating Area

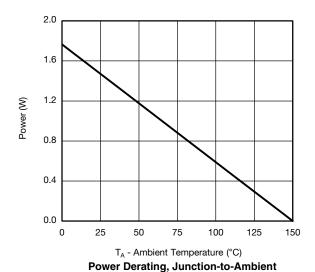




T<sub>C</sub> - Case Temperature (°C)

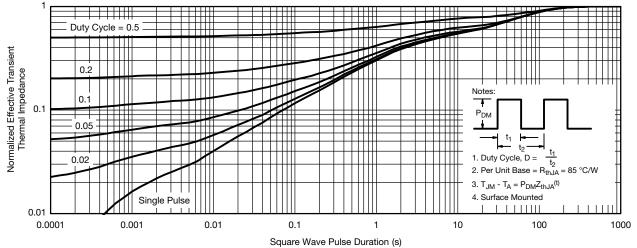
Current Derating\*



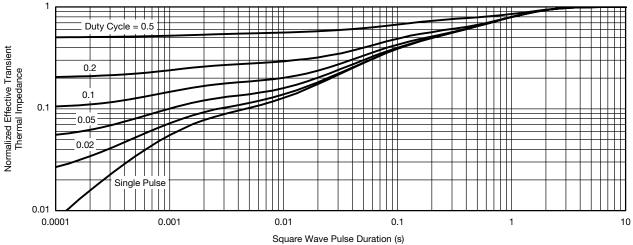


<sup>\*</sup> The power dissipation  $P_D$  is based on  $T_{J(max)}$  = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.





Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Foot



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